WINSTAR Display

OLED SPECIFICATION

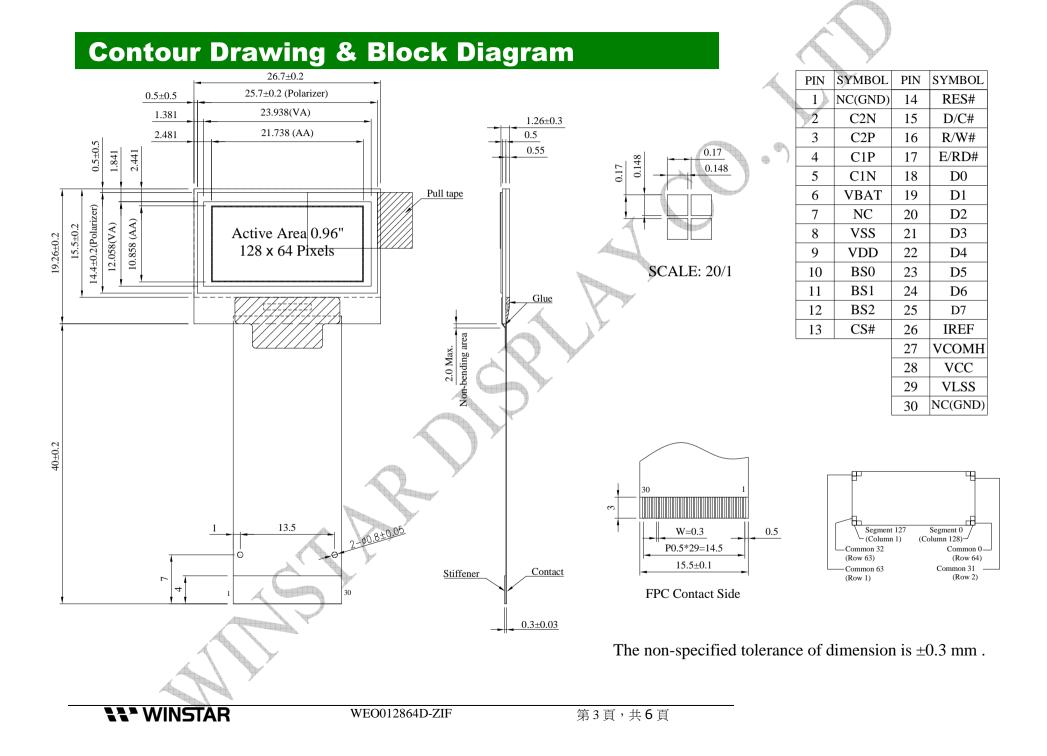
Model No:

WEO012864D-ZIF

General Specification

ltem	Dimension	Unit				
Dot Matrix	128 x 64 Dots					
Module dimension	26.70 x 19.26 x 1.26	mm				
Active Area	21.738 x 10.858	mm				
Pixel Size	0.148 x 0.148	mm				
Pixel Pitch	0.17 x 0.17	mm				
Display Mode	Passive Matrix					
Display Color	Monochrome					
Drive Duty	1/64 Duty					
IC	SSD1306BZ					
Interface	6800,8080,SPI,I2C					
Size	0.96 inch					

WINSTAR



Interface Pin Function

	No.	Symbol	Function								
			Reserved Pin (Supporting Pin)								
	1	(GND)	The supporting pins can reduce the influences from stresses on the								
			function pins. These pins must be connected to external ground.								
	2	C2N	Positive Terminal of the Flying Inverting Capacitor Negative Terminal of								
	3	C2P	the Flying Boost Capacitor The charge-pump capacitors are required								
	4	C1P	between the terminals. They must be floated when the converter is not								
	5	C1N	used.								
			Power Supply for DC/DC Converter Circuit								
	6	6 VBAT					ouffer of the DC/DC voltage				
converter. It must be connected to e							to external source when the converter is				
		he converter is not used.									
	7	NC	NC			A					
			Ground of Logic Circuit			1					
	8	VSS				rence fo	or the logic pins. It must be				
-			connected to external g		J.	alan-	· · · · · · · · · · · · · · · · · · ·				
	9	VDD	Power Supply for Logic								
	Ŭ	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,			4900	pe conne	ected to external source.				
	10	D 00	Communicating Protoc			Y.M.					
	10	BS0	These pins are MCU in	terfac	e select	ion inpu	it. See the				
			following table:								
	11	BS1		BS0	BS1	BS2					
	11	001	I2C 3-wire SPI	0	1	0					
-			4-wire SPI	0	õ	ŏ					
	12	BS2	8-bit 68XX Parallel	0	0	1					
			8-bit 80XX Parallel	0	1	1					
-			Chip Select								
	13	CS#	This pin is the chip sele	ect inp	ut. The	chip is e	enabled for MCU				
			communication only wh	nen CS	S# is pu	lled low.					
			Power Reset for Control	oller a	nd Drive	ər					
	14	RES#	This pin is reset signal	input.	When t	he pin is	s low, initialization of the chip				
		A	is executed.								
	4		Data/Command Control								
							n the pin is pulled high, the				
	input at D7~D0 is treated as display data. When the pin is pulled low, the input at D7~D0 will be transferred command register. For detail relationship to MCU interface signal										
A											
× \											
		2/0//	please refer to the Timing Characteristics Diagrams.								
					d serial interface mode is selected, the						
-48	data at SDIN is treated as data. When it is pulled low, the data at SI										
			will be transferred to the command register. In I2C mode, this pin acts as								
		SA0 for slave address selection.									

16	R/W#	Read/Write Select or Write This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as Read/Write (R/W#) selection input. Pull this pin to "High" for read mode and pull it to "Low" for write mode. When 80XX interface mode is selected, this pin will be the Write (WR#) input. Data write operation is initiated when this pin is pulled low and the CS# is pulled low.
17	E/RD#	Read/Write Enable or Read This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled high and the CS# is pulled low. When connecting to an 80XX-microprocessor, this pin receives the Read (RD#) signal. Data read operation is initiated when this pin is pulled low and CS# is pulled low.
18~25	D0~D7	Host Data Input/Output Bus These pins are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK. When I2C mode is selected, D2 & D1 should be tired together and serve as SDAout & SDAin in application and D0 is the serial clock input SCL.
26	IREF	Current Reference for Brightness Adjustment This pin is segment current reference pin. A resistor should be connected between this pin and VSS. Set the current lower than 12.5µA.
27	VCOMH	Voltage Output High Level for COM Signal This pin is the input pin for the voltage output high level for COM signals. A capacitor should be connected between this pin and VSS.
28	vcc	Power Supply for OEL Panel This is the most positive voltage supply pin of the chip. A stabilization capacitor should be connected between this pin and VSS when the converter is used. It must be connected to external source when the converter is not used.
29	VLSS	Ground of Analog Circuit This is an analog ground pin. It should be connected to VSS externally.
30	NC (GND)	Reserved Pin (Supporting Pin) The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground.
	7	

Absolute Maximum Ratings

Symbol	Min	Мах	Unit
VDD	0	4.0	V
VCC	0	15.0	V
TOP	-40	+80	°C
TSTG	-40	+85	°C
	VDD VCC TOP	VDD 0 VCC 0 TOP -40	VDD 0 4.0 VCC 0 15.0 TOP -40 +80

Electrical Characteristics

DC Electrical Characteristics

ltem	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage for Logic	VDD		2.8	3.0	3.3	V
Supply Voltage for Display	VCC	X	11.5	12.0	12.5	V
Input High Volt.	VIH	L,	0.8×VDD	_	VDDIO	V
Input Low Volt.	VIL	_	0	_	0.2×VDD	V
Output High Volt.	VOH	_	0.9×VDD	_	VDDIO	V
Output Low Volt.	VOL	_	0	_	0.1×VDD	V
Operating Current for VCC (50% display ON)	ICC			19.5	25.0	mA